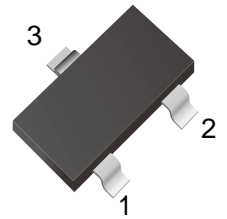
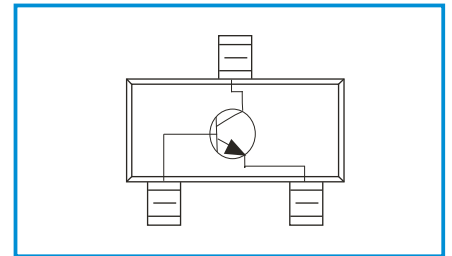


Transistor(NPN)

Features

- Complement to LTBTA93
- Power Dissipation of 350mW
- High Stability and High Reliability

1. BASE
2. EMITTER
3. COLLECTOR


Functional Diagram


Mechanical Data

- SOT-23 Small Outline Plastic Package
- Epoxy UL: 94V-0
- Mounting Position: Any
- Marking: ABX

Maximum Ratings (Ta=25 unless otherwise noted)

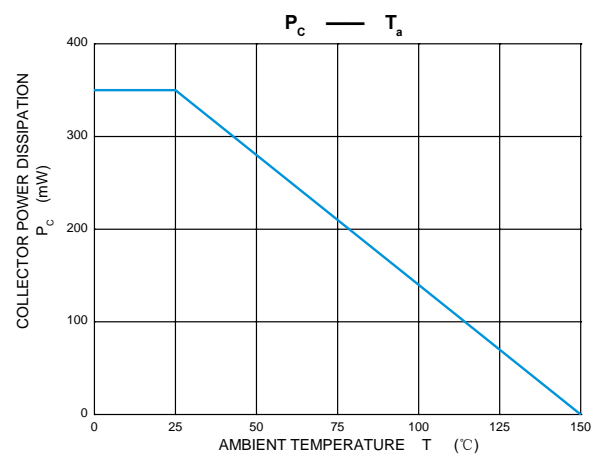
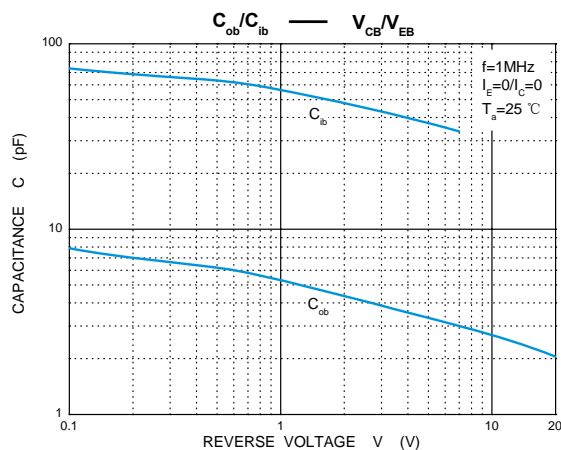
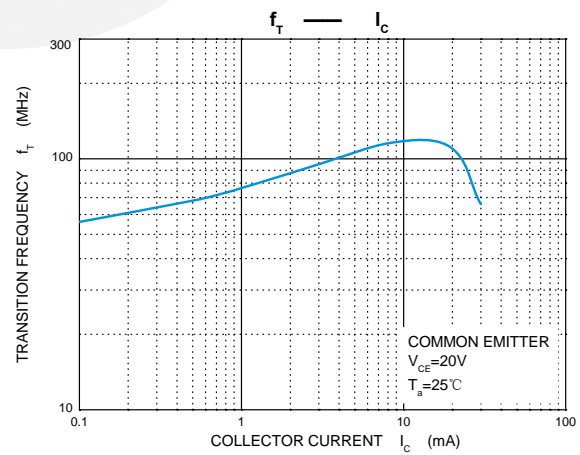
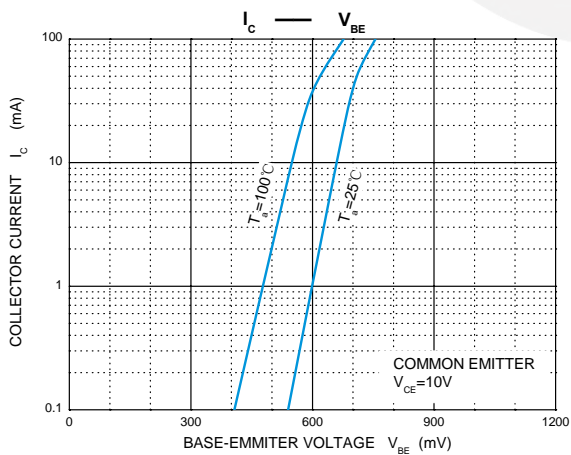
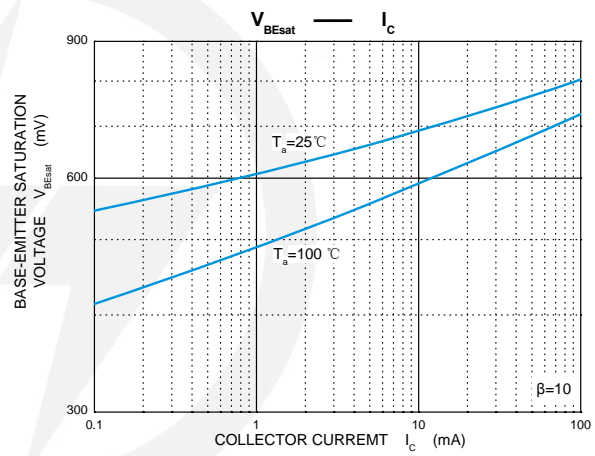
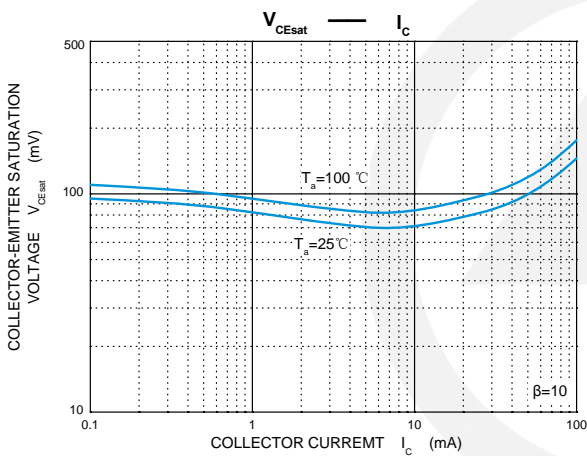
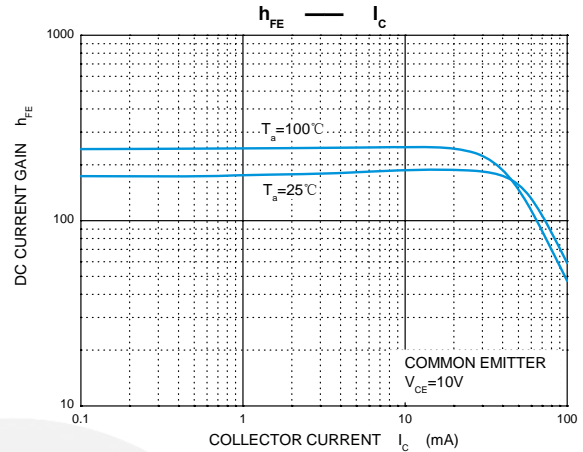
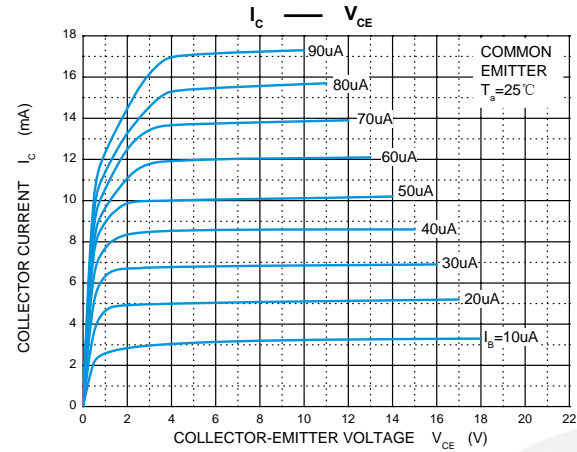
| Parameters | Symbol | Value | Unit |
|---|-----------------|----------|------|
| Collector-Base Voltage | V_{CBO} | 200 | V |
| Collector-Emitter Voltage | V_{CEO} | 200 | V |
| Emitter -Base Voltage | V_{EBO} | 5 | V |
| Collector Current-Continuous | I_C | 500 | mA |
| Collector Power Dissipation | P_C | 350 | mW |
| Junction Temperature | T_j | 150 | °C |
| Storage Temperature | T_{stg} | -55-+150 | °C |
| Thermal resistance From junction to ambient | $R_{\theta JA}$ | 357 | °C/W |

Electrical characteristics (Ta=25 unless otherwise specified)

| Parameter | Symbols | Test Condition | Limits | | Unit |
|--------------------------------------|----------------|----------------------------------|--------|------|------|
| | | | Min | Max | |
| Collector-base breakdown voltage | $V_{(BR)CBO}$ | $I_C=100\mu A, I_E=0$ | 200 | | V |
| Collector-emitter breakdown voltage | $V_{(BR)CEO}$ | $I_C=1mA, I_B=0$ | 200 | | V |
| Emitter-base breakdown voltage | $V_{(BR)EBO}$ | $I_E=10\mu A, I_C=0$ | 5 | | V |
| Collector cut-off current | I_{CBO} | $V_{CB}=100V, I_E=0$ | | 250 | nA |
| Emitter cut-off current | I_{EBO} | $V_{EB}=5V, I_C=0$ | | 100 | nA |
| DC current gain | $h_{FE(1)*}$ | $V_{CE}=10V, I_C=10mA$ | 40 | | |
| | $h_{FE(2)*}$ | $V_{CE}=10V, I_C=1mA$ | 40 | | |
| | $h_{FE(3)*}$ | $V_{CE}=10V, I_C=30mA$ | 40 | | |
| Collector-emitter saturation voltage | $V_{CE(sat)*}$ | $I_C=20mA, I_B=2mA$ | | 0.50 | V |
| Base -emitter saturation voltage | $V_{BE(sat)*}$ | $I_C=20mA, I_B=2mA$ | | 0.90 | V |
| Transition frequency | f_T | $V_{CE}=20V, I_C=100mA; f=30MHz$ | 50 | | MHz |
| Collector output capacitance | C_{ob} | $V_{CB}=20V, I_E=0, f=1MHz$ | | 4 | pF |

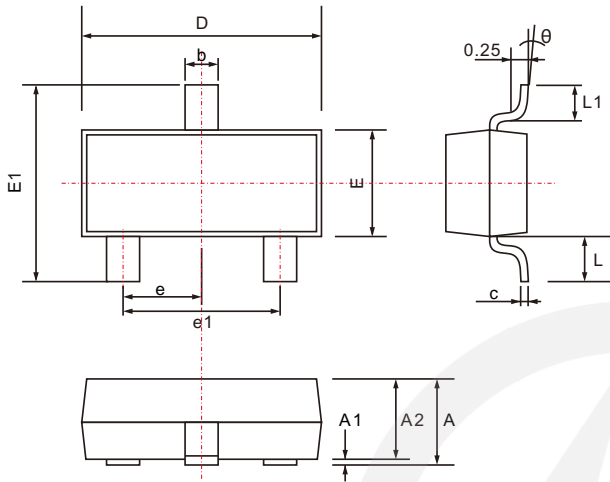
*Pulse test: pulse width $\leq 300\mu s$, duty cycle $\leq 2.0\%$.

Typical Characteristics



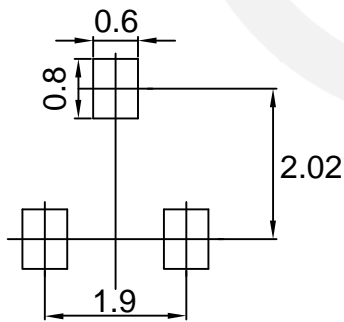
SOT-23 Package Outline

Unit: mm



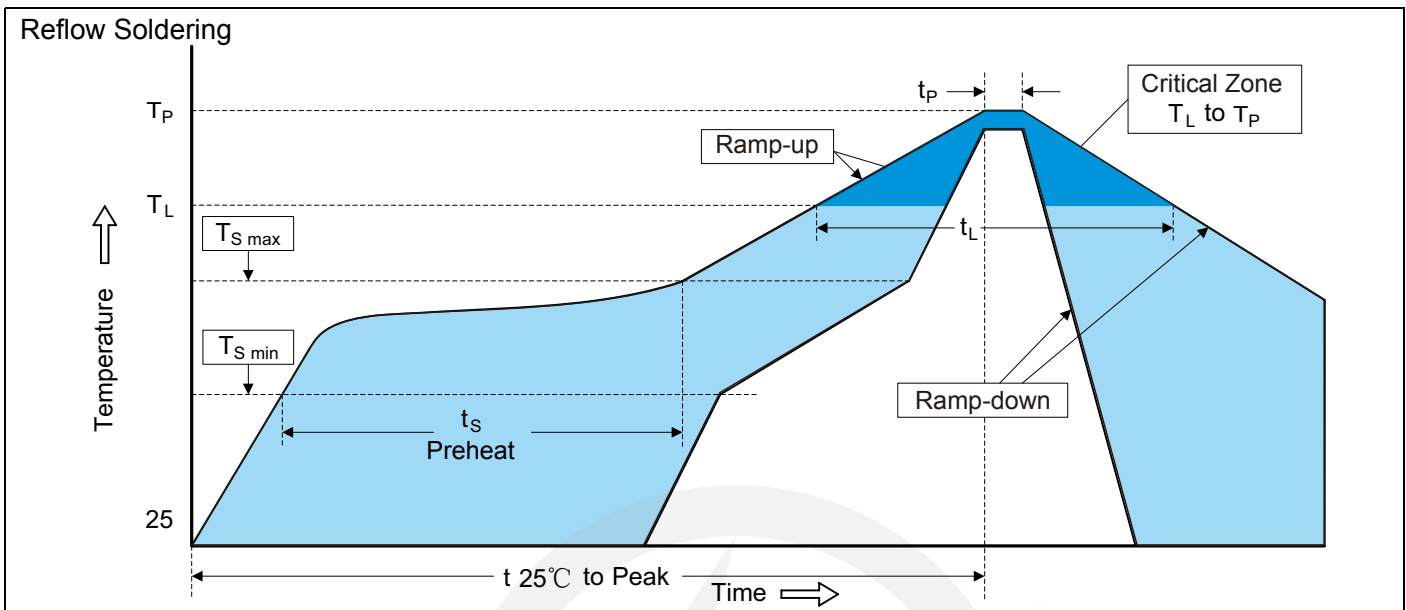
| SYMBOL | DIMENSIONS | |
|--------|------------|-------|
| | MIN. | MAX. |
| A | 0.900 | 1.200 |
| A1 | 0.000 | 0.100 |
| A2 | 0.900 | 1.050 |
| b | 0.300 | 0.500 |
| c | 0.080 | 0.200 |
| D | 2.700 | 3.100 |
| E | 1.200 | 1.400 |
| E1 | 2.200 | 3.000 |
| e | 0.950 TYP. | |
| e1 | 1.750 | 2.050 |
| L | 0.550 TYP. | |
| L1 | 0.300 | 0.500 |
| θ | 0° | 8° |

SOT-23 Suggested Pad Layout

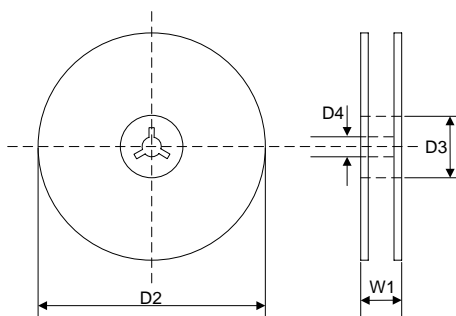


Note:

1. Controlling dimension: in millimeters.
2. General tolerance: $\pm 0.05\text{mm}$
3. The pad layout is for reference purpose only.

Recommended Soldering Conditions

Recommended Conditions

| Profile Feature | Pb-Free Assembly |
|---|----------------------------------|
| Average ramp-up rate (T_L to T_P) | 3°C/second max. |
| Preheat -Temperature Min ($T_{S\ min}$) -Temperature Max ($T_{S\ max}$) -Time (min to max) (t_s) | 150°C 200°C 60-180 seconds |
| $T_{S\ max}$ to T_L -Ramp-up Rate | 3°C/second max. |
| Time maintained above: -Temperature (T_L) -Time (t_L) | 217°C 60-150 seconds |
| Peak Temperature (T_P) | 260°C |
| Time within 5°C of actual Peak Temperature (t_P) | 20-40 seconds |
| Ramp-down Rate | 6°C/second max. |
| Time 25°C to Peak Temperature | 8 minutes max. |

7" Reel


| | |
|----|----------------------|
| D2 | $\Phi 178.0 \pm 2.0$ |
|----|----------------------|

| | |
|----|--------------------------|
| D3 | $\Phi 50.0 \text{ Min.}$ |
|----|--------------------------|

| | |
|----|---------------------|
| D4 | $\Phi 13.0 \pm 0.5$ |
|----|---------------------|

| | |
|----|----------------|
| W1 | 16.0 ± 2.0 |
|----|----------------|

Quantity: 3000PCS